

April 30, 2019



Summit Wireless Technologies to Participate in Four Upcoming Investor Conferences

SAN JOSE, Calif.--(BUSINESS WIRE)-- [Summit Wireless Technologies, Inc.](http://www.summitwireless.com) (NASDAQ: WISA), a leading provider of immersive, wireless sound technology for intelligent devices and next-generation home entertainment systems, announced that President and CEO Brett Moyer is scheduled to participate in the following upcoming conferences.

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| May 7 th | Trickle Research Rocky Mountain Microcap Conference IV
Coors Field in Denver, Colorado
Presentation at 11:26 a.m. CT |
| May 21 st -22 nd | B. Riley FBR Institutional Investor Conference
Beverly Hilton in Beverly Hills, California
1x1 meetings |
| May 30 th | Ladenburg Thalmann Technology Expo 2019
Convene in New York, New York
Presentation at 8:00 a.m. ET, 1x1 meetings |
| June 4 th | LD Micro Invitational
The Luxe Sunset in Bel-Air, California
Presentation at 1:40 p.m. PT, 1x1 meetings |

Presentation materials will be posted on the Investor Relations portion of the company's website at www.summitwireless.com. Interested parties may contact their representatives at the above firms to arrange meetings at the respective events.

About Summit Wireless Technologies, Inc.

Summit Wireless Technologies, Inc. (NASDAQ: WISA) is a leading provider of immersive, wireless sound technology for intelligent devices and next generation home entertainment systems. Working with leading CE brands and manufacturers such as Harman International, a division of Samsung, LG Electronics, Klipsch, Bang & Olufsen, Xbox, a subsidiary of Microsoft, and others, Summit Wireless delivers seamless, dynamic audio experiences for

high-definition content, including movies and video, music, sports, gaming/esports, and more. Summit Wireless is a founding member of WiSA, the Wireless Speaker and Audio Association and works in joint partnership to champion the most reliable interoperability standards across the audio industry. Summit Wireless, formerly named Summit Semiconductor, Inc., is headquartered in San Jose, CA with sales teams in Taiwan, China, Japan, and Korea. For more information, please visit: www.summitwireless.com.

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